IR Detector for Mid Range Proximity Sensor

FEATURES
- Height of 0.8 mm
- Up to 2 m for proximity sensing
- Receives 38 kHz modulated signal
- Photo detector and preamplifier in one package
- Low supply current
- Shielding against EMI
- Visible light is suppressed by IR filter
- Insensitive to supply voltage ripple and noise
- Supply voltage: 2.5 V to 5.5 V
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS
- Object approach detection for activation of displays and user consoles, signaling of alarms, etc.
- Simple gesture controls
- Differentiation of car arrival, static, car departure in parking lots
- Reflective sensors for toilet flush
- Navigational sensor for robotics

DESCRIPTION
The TSSP57P38 is a compact infrared detector module for proximity sensing application. It receives 38 kHz modulated signals and has a peak sensitivity of 940 nm.

The length of the detector’s output pulse varies in proportion to the amount of light reflected from the object being detected.

ORDERING CODE
Taping:
TSSP57P38TT1 - top view taped
TSSP57P38TT2 - top view taped

PARTS TABLE

<table>
<thead>
<tr>
<th>Carrier frequency</th>
<th>Package</th>
<th>Pinning</th>
<th>Dimensions (mm)</th>
<th>Mounting</th>
<th>Application</th>
</tr>
</thead>
<tbody>
<tr>
<td>38 kHz</td>
<td>Belobog</td>
<td>1 = OUT, 2, 3, 6, 7, 8 = GND, 4, 5 = VS</td>
<td>3.95 W x 3.95 H x 0.8 D</td>
<td>SMD</td>
<td>Proximity sensors</td>
</tr>
</tbody>
</table>
**BLOCK DIAGRAM**

**PROXIMITY SENSING**

![Block Diagram](image)

**ABSOLUTE MAXIMUM RATINGS**

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>TEST CONDITION</th>
<th>SYMBOL</th>
<th>VALUE</th>
<th>UNIT</th>
</tr>
</thead>
<tbody>
<tr>
<td>Supply voltage</td>
<td>V_S</td>
<td>-0.3</td>
<td>to +6 V</td>
<td></td>
</tr>
<tr>
<td>Supply current</td>
<td>I_S</td>
<td>5 mA</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Output voltage</td>
<td>V_O</td>
<td>-0.3</td>
<td>to (V_S + 0.3)</td>
<td>V</td>
</tr>
<tr>
<td>Output current</td>
<td>I_O</td>
<td>5 mA</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Junction temperature</td>
<td>T_J</td>
<td>100°C</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Storage temperature range</td>
<td>T_stg</td>
<td>-25 to</td>
<td>+85 °C</td>
<td></td>
</tr>
<tr>
<td>Operating temperature range</td>
<td>T_amb</td>
<td>-25 to</td>
<td>+85 °C</td>
<td></td>
</tr>
<tr>
<td>Power consumption</td>
<td>P_tot</td>
<td>10 mW</td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

**ELECTRICAL AND OPTICAL CHARACTERISTICS** (T_amb = 25 °C, unless otherwise specified)

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>TEST CONDITION</th>
<th>SYMBOL</th>
<th>MIN.</th>
<th>TYP.</th>
<th>MAX.</th>
<th>UNIT</th>
</tr>
</thead>
<tbody>
<tr>
<td>Supply voltage</td>
<td>V_S</td>
<td>2.5</td>
<td>-</td>
<td>5.5</td>
<td>V</td>
<td></td>
</tr>
<tr>
<td>Supply current</td>
<td>I_SD</td>
<td>0.55</td>
<td>0.7</td>
<td>0.9</td>
<td>mA</td>
<td></td>
</tr>
<tr>
<td>Receiving distance</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Direct line of sight,</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>IR diode TSAL6200, IF = 50 mA,</td>
<td>d</td>
<td>-</td>
<td>18</td>
<td>-</td>
<td>m</td>
<td></td>
</tr>
<tr>
<td>test signal see Fig. 1</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Output voltage low</td>
<td>I_OSL</td>
<td>0.5 mA</td>
<td>0.7</td>
<td>0.9</td>
<td>mA</td>
<td></td>
</tr>
<tr>
<td>Minimum irradiance</td>
<td>E_e min.</td>
<td>-</td>
<td>0.2</td>
<td>0.4</td>
<td>mW/m²</td>
<td></td>
</tr>
<tr>
<td>Maximum irradiance</td>
<td>E_e max.</td>
<td>50</td>
<td>-</td>
<td>-</td>
<td>W/m²</td>
<td></td>
</tr>
<tr>
<td>Directivity</td>
<td>θ_1/2</td>
<td>-</td>
<td>± 75</td>
<td>-</td>
<td>deg</td>
<td></td>
</tr>
</tbody>
</table>
**TYPICAL CHARACTERISTICS**  \((T_{\text{amb}} = 25 \, ^\circ \text{C}, \text{unless otherwise specified})\)

**Output Active Low**

- **Optical Test Signal**
  - (IR diode TSAL6200, \(I_p = 0.4 \, \text{A}, 30 \, \text{pulses}, f = f_0, t = 10 \, \text{ms}\))

  \[ t_{p1} > 10/f_0 \] is recommended for optimal function

- **Output Signal**
  - \(V_O\)
  - \(V_{OH}\)
  - \(V_{OL}\)

- **Optical Test Signal, Fig. 1**

  \[ 1) \quad 7/f_0 < t_d < 15/f_0 \]
  \[ 2) \quad t_{p1} - 5/f_0 < t_p < t_{p1} + 6/f_0 \]

- **Output Pulse Width**

- **Input Burst Length**

  \(\lambda = 950 \, \text{nm}, \) Optical Test Signal, Fig. 1

- **Fig. 1 - Output Active Low**

**Sensitivity in Bright Ambient**

- **Correlation with Ambient Light Sources**
  - \(10 \, \text{W/m}^2 = 1.4 \, \text{kLx} \text{ (Std. Illum. A, } T = 2855 \, \text{K)} \)
  - \(10 \, \text{W/m}^2 = 8.2 \, \text{kLx} \text{ (Daylight, } T = 5900 \, \text{K)} \)

- **Fig. 4 - Sensitivity in Bright Ambient**

**Frequency Dependence of Responsivity**

- **\(E_{e_{\text{min}}}/E_{e}\) - Rel. Responsivity**

  \[ f = f_0 \pm 5\% \]
  \[ \Delta f (3 \, \text{dB}) = f_0/10 \]

- **Fig. 3 - Frequency Dependence of Responsivity**

**Sensitivity vs. Supply Voltage Disturbances**

- **Input Burst Length = 300 ms, \(f = f_0\)**

- **Fig. 5 - Sensitivity vs. Supply Voltage Disturbances**

**Output Pulse Width vs. Irradiance**

- **Input Burst Length = 300 ms, \(f = f_0\)**

- **Fig. 6 - Output Pulse Width vs. Irradiance**

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**Document Number:** 82480
Fig. 7 - Sensitivity vs. Ambient Temperature

Fig. 8 - Relative Spectral Sensitivity vs. Wavelength

Fig. 9 - Max. Rate of Bursts

Fig. 10 - Angle Characteristic

Fig. 11 - $t_{po}$ vs. Distance

Fig. 12 - Dynamic Range of Sensor vs. $t_{pi}$
The typical application of the TSSP57P38 is a reflective sensor with analog information contained in its output. Such a sensor is evaluating the time required by the AGC to suppress a quasi continuous signal. The time required to suppress such a signal is longer when the signal is strong than when the signal is weak, resulting in a pulse length corresponding to the distance of an object from the sensor. This kind of analog information can be evaluated by a microcontroller. The absolute amount of reflected light depends much on the environment and is not evaluated. Only sudden changes of the amount of reflected light, and therefore changes in the pulse width, are evaluated using this application.

Example of a signal pattern:

![Signal Pattern Diagram]

Example for a sensor hardware:

![Sensor Hardware Diagram]

There should be no common window in front of the emitter and receiver in order to avoid crosstalk by guided light through the window.

The logarithmic characteristic of the AGC in the TSSP57P38 results in an almost linear relationship between distance and pulse width. Ambient light has also some impact to the pulse width of this kind of sensor, making the pulse shorter.
PACKAGE DIMENSIONS in millimeters

Technical drawings according to DIN specifications

Not indicated tolerances ± 0.1

Drawing-No.: 6.550-5315.01-4
Issue: 2; 12.02.14

Pin 1 Identification
marking area

Pin 1 Identification

Notes
(1) Optically effective area
(2) Pins connected internally. It is not necessary to connect externally
ASSEMBLY INSTRUCTIONS

Reflow Soldering

- Reflow soldering must be done within 168 h while stored under a max. temperature of 30 °C, 60 % RH after opening the dry pack envelope.
- Set the furnace temperatures for pre-heating and heating in accordance with the reflow temperature profile as shown in the diagram. Exercise extreme care to keep the maximum temperature below 260 °C. The temperature shown in the profile means the temperature at the device surface. Since there is a temperature difference between the component and the circuit board, it should be verified that the temperature of the device is accurately being measured.
- Handling after reflow should be done only after the work surface has been cooled off.

Manual Soldering

- Use a soldering iron of 25 W or less. Adjust the temperature of the soldering iron below 300 °C.
- Finish soldering within 3 s.
- Handle products only after the temperature has cooled off.

VISHAY LEAD (Pb)-FREE REFLOW SOLDER PROFILE

ORDERING INFORMATION

<table>
<thead>
<tr>
<th>ORDERING CODE</th>
<th>PACKAGING</th>
<th>VOLUME (1)</th>
<th>REMARKS</th>
</tr>
</thead>
<tbody>
<tr>
<td>TSSP57P38TT1</td>
<td>Tape and reel</td>
<td>MOQ: 1800 pcs</td>
<td>3.95 mm x 3.95 mm x 0.75 mm</td>
</tr>
<tr>
<td>TSSP57P38TT2</td>
<td></td>
<td>MOQ: 7000 pcs</td>
<td></td>
</tr>
</tbody>
</table>

**Note**

(1) MOQ: minimum order quantity
TAPING VERSION TSSP57P38 DIMENSIONS in millimeters

Tape and reel dimensions:

- Reel size "Y" TT1 Ø 180 ± 2 = 1800 pcs.
- Unreel direction
- Tape position coming out from reel
- Label posted here
- Parts mounted
- Empty leader 400 mm min.
- Direction of pulling out
- Technical drawings according to DIN specifications

Leader and trailer tape:
- Empty trailer 200 mm min.
- Direction of pulling out

Drawing-No.: 9.700-5347.01-4
Issue: 2; 07.03.18

Not indicated tolerances ± 0.1
**LABEL**

**Standard bar code labels for finished goods**

The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

<table>
<thead>
<tr>
<th><strong>VISHAY SEMICONDUCTOR GmbH STANDARD BAR CODE PRODUCT LABEL</strong> (finished goods)</th>
</tr>
</thead>
<tbody>
<tr>
<td><strong>PLAIN WRITING</strong></td>
</tr>
<tr>
<td>Item-description</td>
</tr>
<tr>
<td>Item-number</td>
</tr>
<tr>
<td>Selection-code</td>
</tr>
<tr>
<td>LOT-/serial-number</td>
</tr>
<tr>
<td>Data-code</td>
</tr>
<tr>
<td>Plant-code</td>
</tr>
<tr>
<td>Quantity</td>
</tr>
<tr>
<td>Accepted by</td>
</tr>
<tr>
<td>Packed by</td>
</tr>
<tr>
<td>Mixed code indicator</td>
</tr>
<tr>
<td>Origin</td>
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</table>

<table>
<thead>
<tr>
<th><strong>Long bar code top</strong></th>
<th><strong>Type</strong></th>
<th><strong>Length</strong></th>
</tr>
</thead>
<tbody>
<tr>
<td>Item-number</td>
<td>N</td>
<td>8</td>
</tr>
<tr>
<td>Plant-code</td>
<td>N</td>
<td>2</td>
</tr>
<tr>
<td>Sequence-number</td>
<td>X</td>
<td>3</td>
</tr>
<tr>
<td>Quantity</td>
<td>N</td>
<td>8</td>
</tr>
<tr>
<td>Total length</td>
<td>-</td>
<td>21</td>
</tr>
</tbody>
</table>

<table>
<thead>
<tr>
<th><strong>Short bar code bottom</strong></th>
<th><strong>Type</strong></th>
<th><strong>Length</strong></th>
</tr>
</thead>
<tbody>
<tr>
<td>Selection-code</td>
<td>X</td>
<td>3</td>
</tr>
<tr>
<td>Data-code</td>
<td>N</td>
<td>3</td>
</tr>
<tr>
<td>Batch-number</td>
<td>X</td>
<td>10</td>
</tr>
<tr>
<td>Filter</td>
<td>-</td>
<td>1</td>
</tr>
<tr>
<td>Total length</td>
<td>-</td>
<td>17</td>
</tr>
</tbody>
</table>

**DRY PACKING**

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.

**FINAL PACKING**

The sealed reel is packed into a cardboard box.

**RECOMMENDED METHOD OF STORAGE**

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 168 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

- 192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air / nitrogen) or
- 96 h at 60 °C + 5 °C and < 5 % RH for all device containers or
- 24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC® standard J-STD-020 level 3 label is included on all dry bags.
Caution
This bag contains
MOISTURE-SENSITIVE DEVICES

1. Calculated shelf life in sealed bag: 12 months at <40°C and <90% relative humidity (RH)
2. Peak package body temperature: 260°C
3. After bag is opened, devices that will be subjected to reflow solder or other high temperature process must be
   a) Mounted within: 168 hours of factory conditions ≤30°C/60% RH, or
   b) Stored per J-STD-033
4. Devices require bake, before mounting, if:
   a) Humidity Indicator Card reads >10% for level 2a - 5a devices or >60% for level 2 devices when read at 23±5°C
   b) 3a or 3b are not met
5. If baking is required, refer to IPC/JEDEC J-STD-033 for bake procedure

Note: Level and body temperature defined by IPC/JEDEC J-STD-020

EIA JEDEC standard J-STD-020 level 3 label is included on all dry bags

ESD PRECAUTION
Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS
The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.

BAR CODE PRODUCT LABEL (Example)
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